



Media Release

UTAC Begins Testing Of Satellite Communications Chip For GCT Semiconductor, Inc.

SINGAPORE, 14 February 2006 – Singapore Exchange-listed United Test and Assembly Center Ltd (“UTAC” – SGX: UTAC), a leading independent global provider of semiconductor assembly and test services, announced today that it has begun testing of satellite communications chips for GCT Asia Pacific, Inc., the Korean division of GCT Semiconductor, Inc. (“GCT”).

UTAC has begun volume testing of GCT’s GDM7001 CMOS satellite TV tuner single chip, the world’s first VLSI IC (“Very Large Scale Integration Integrated Circuit”) to combine diverse RF (“Radio Frequency”) receivers, channel decoders and controller for Mobile Satellite Broadcasting/Satellite-Digital Multimedia Broadcasting (“MSB/S-DMB”) applications in Japan and Korea. Testing will be carried out at UTAC’s Singapore facilities.

GCT estimates that there are currently over 300,000 subscribers to S-DMB services in Korea, with domestic demand expected to increase rapidly in 2006 as handset vendors launch S-DMB enabled CDMA handsets. In Japan, GCT estimates that there are currently just a few thousand subscribers to MSB services, but expects demand to increase rapidly as video-enabled handsets are introduced in late 2006 and 2007.

“We are pleased to have UTAC as one of our key partners to support the production of our world-leading CMOS satellite single chip tuner semiconductor solution,” said Dr Kyeongho Lee, President and CEO of GCT.



Continued Dr Lee, “Demand for our industry-leading solution has been positive since we announced the chip in June 2005. Hence, we are glad to partner with a leader who has the expertise and scale with which to support our needs.”

“UTAC is proud to be chosen by GCT to participate in the process of bringing this leading-edge satellite tuner chip to the market which we believe will enable a new form of mobile digital entertainment over wireless broadband connections,” said Ms June Chia, Group Executive Vice President of UTAC. “This partnership is very much in line with our push to focus on the Broadband, Mobile and Wireless (“BM/W”) and Mixed Signal and Logic Processing (“MSLP”) semiconductor application sectors.”

GCT Semiconductor is a leading fabless semiconductor company that designs, develops and markets innovative integrated circuit solutions for the wireless communications industry. With its proven CMOS radio frequency (RF) and SOC expertise, GCT provides state-of-the-art CMOS RF transceivers, CMOS single-chip Satellite-DMB digital tuners for mobile handset solutions offering handset manufacturers reduced component cost, lower power consumption and smaller footprint. GCT also offers complete Unlicensed Mobile Access (UMA) and SIP-based VoWLAN solutions to achieve best-in-class handset talk times that support both VoWLAN and Bluetooth simultaneously. Working with cellular platform partners, GCT offers complete handset reference designs, with proven expertise in digital signal processing and modems..

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About GCT Semiconductor, Inc.

GCT Semiconductor is a fabless semiconductor company that designs, develops and markets innovative integrated circuit solutions for the wireless communications industry. The company's patented direct conversion architecture, which is the basis for GCT's radio frequency (RF) core, can efficiently support multimode applications and be fabricated on standard CMOS processes. This versatile RF architecture can support many of the wireless communication standards, including PHS, GSM/GPRS, WCDMA and EDGE. The company's web site can be found at www.gctsemi.com.

About United Test and Assembly Center Ltd (“UTAC”)

Established in 1997 and listed on the Main Board of the Singapore Exchange, UTAC is a leading independent provider of semiconductor assembly and testing services to its customers, which comprise integrated device manufacturers (“IDMs”), fabless companies and wafer foundries. UTAC provides wafer probing and final testing services on a diverse selection of test platforms for a range of semiconductors including memory, logic, mixed-signal and radio-frequency ICs. Besides testing services, UTAC also provides assembly services for a broad range of leadframe and array packages.

Headquartered in Singapore where it houses its manufacturing, test engineering and package design facilities, UTAC has established a global network of sales offices in the United States, Europe, Japan, Korea and China. It also has wholly-owned subsidiaries in China and Taiwan to provide wafer probing and testing services. For more information, visit www.utacgroup.com



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